

Kulicke & Soffa Industries, Inc.

Kulicke & Soffa to Participate in SEMICON Taiwan 2019

SINGAPORE--(BUSINESS WIRE)--Sep. 13, 2019-- Kulicke & Soffa Industries, Inc. (NASDAQ:KLIC) (“Kulicke & Soffa”, “K&S” or “Company”) announced today that it will be participating at the SEMICON Taiwan 2019 trade show in Taipei, Taiwan, from September 18 through September 20, 2019.

Kulicke & Soffa will be showcasing the RAPID™ MEM, *Gen-S Series* of automatic wire bonder engineered to enable Industry 4.0 communication and is RoHS compliant. Its advanced process features such as real-time monitoring and diagnostics capabilities ensures quality and efficient assembly serving high-performance and high-reliability semiconductor applications.

In addition to the RAPID™ MEM wire bonder, the Company will also be demonstrating its Industry 4.0 connectivity software solutions – KNet PLUS and Auto OLP 2019 (auto offline programming). These solutions have been successfully deployed and implemented at customer sites globally to enhance quality, improve productivity and manage machine performance. Also, a 3D overview of the Liteq 500 projection stepper’s unique architecture and features will be available along with an augmented reality demonstration that highlights the ease and flexibility of the Asterion wedge bonder’s bond tool change-over capabilities.

Hoang Huy Hoang, Executive Vice President of K&S, stated, “K&S continues to partner with customers in many different application spaces to develop disruptive and market-leading solutions. We continue to push the boundaries, enter new markets and deliver high-value solutions to our customers and the industry.”

Customers could visit K&S’s booth #M0640/ 4Fin Taipei Nangang Exhibition Center, Hall 1 (TaiNEX 1) to discuss more on their technological needs.

About Kulicke & Soffa

Kulicke & Soffa (NASDAQ: KLIC) is a leading provider of semiconductor and electronic assembly solutions serving the global automotive, consumer, communications, computing and industrial markets. Founded in 1951, K&S prides itself on establishing foundations for technological advancement - creating pioneering interconnect solutions that enable performance improvements, power efficiency, form-factor reductions and assembly excellence of current and next-generation semiconductor devices.

Leveraging decades of development proficiency and extensive process technology expertise, Kulicke & Soffa’s expanding portfolio provides equipment solutions, aftermarket products and services supporting a comprehensive set of interconnect technologies including wire bonding, advanced packaging, lithography, and electronics assembly. Dedicated to empowering technological discovery, always, K&S collaborates with customers and technology partners to push the boundaries of possibility, enabling a smarter future (www.kns.com).

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Marilyn Sim

Public Relations

P: +65-6880-9309

F: +65-6880-9580

msim@kns.com

Kulicke & Soffa Industries, Inc.
Joseph Elgindy
Investor Relations & Strategic Initiatives
P: +1-215-784-7500
F: +1-215-784-6180
investor@kns.com

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